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With the principle of “Quality Parts,Customers Priority,Honest Operation,and Considerate Service”,our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip,ALPS,ROHM,Xilinx,Pulse,ON,Everlight and Freescale. Main products comprise IC,Modules,Potentiometer,IC Socket,Relay,Connector.Our parts cover such applications as commercial,industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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## APHF1608SEEQBDZGKC

1.6 x 0.8 mm Full-Color Surface Mount LED

### DESCRIPTIONS

- The Hyper Red source color devices are made with AlGaInP on GaAs substrate Light Emitting Diode
- The Blue source color devices are made with InGaN Light Emitting Diode
- The Green source color devices are made with InGaN on Sapphire Light Emitting Diode
- Electrostatic discharge and power surge could damage the LEDs
- It is recommended to use a wrist band or anti-electrostatic glove when handling the LEDs
- All devices, equipments and machineries must be electrically grounded

### FEATURES

- 1.6 x 0.8 mm SMD LED, 0.5 mm thickness
- Low power consumption
- Package in 8mm tape on 7" diameter reel, 4000 pcs / reel
- Can produce any color in visible spectrum, including white light
- Moisture sensitivity level: 3
- RoHS compliant

### APPLICATIONS

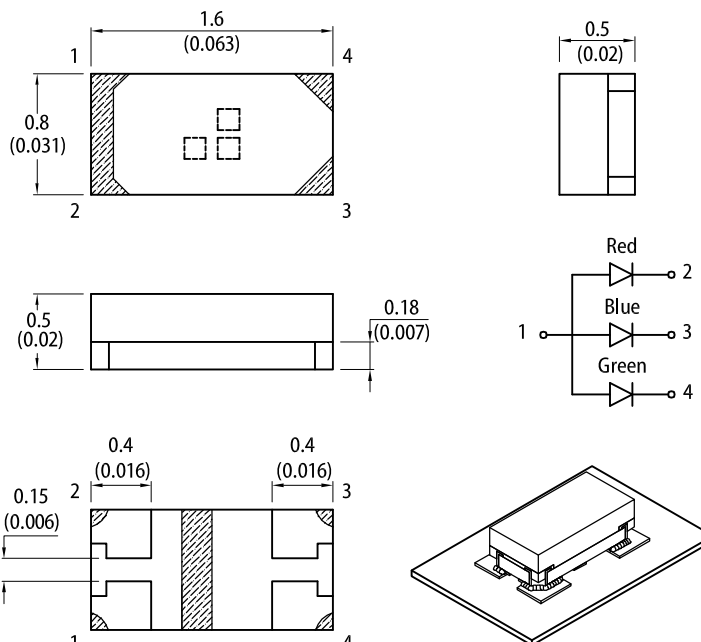
- Backlight
- Status indicator
- Home and smart appliances
- Wearable and portable devices
- Healthcare applications

### ATTENTION

Observe precautions for handling electrostatic discharge sensitive devices

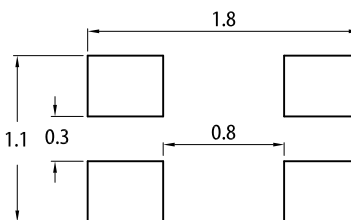


### PACKAGE DIMENSIONS



### RECOMMENDED SOLDERING PATTERN

(units : mm; tolerance : ± 0.1)



#### Notes:

1. All dimensions are in millimeters (inches).
2. Tolerance is ±0.15(0.006") unless otherwise noted.
3. The specifications, characteristics and technical data described in the datasheet are subject to change without prior notice.
4. The device has a single mounting surface. The device must be mounted according to the specifications.

### SELECTION GUIDE

Part Number	Emitting Color (Material)	Lens Type	Iv (mcd) @ 20mA <sup>[2]</sup>		Viewing Angle <sup>[1]</sup>
			Min.	Typ.	2θ1/2
APHF1608SEEQBDZGKC	■ Hyper Red (AlGaInP)	Water Clear	40	120	140°
	■ Blue (InGaN)		20	60	140°
	■ Green (InGaN)		200	480	140°

Notes:  
 1. θ1/2 is the angle from optical centerline where the luminous intensity is 1/2 of the optical peak value.  
 2. Luminous intensity / luminous flux: +/-15%.  
 3. Luminous intensity value is traceable to CIE127-2007 standards.

**ELECTRICAL / OPTICAL CHARACTERISTICS at T<sub>A</sub>=25°C**

Parameter	Symbol	Emitting Color	Value		Unit
			Typ.	Max.	
Wavelength at Peak Emission I <sub>F</sub> = 20mA	λ <sub>peak</sub>	Hyper Red Blue Green	630 460 515	-	nm
Dominant Wavelength I <sub>F</sub> = 20mA	λ <sub>dom</sub> [1]	Hyper Red Blue Green	621 465 525	-	nm
Spectral Bandwidth at 50% Φ REL MAX I <sub>F</sub> = 20mA	Δλ	Hyper Red Blue Green	20 25 35	-	nm
Capacitance	C	Hyper Red Blue Green	25 100 45	-	pF
Forward Voltage I <sub>F</sub> = 20mA	V <sub>F</sub> [2]	Hyper Red Blue Green	2 3.3 3.3	2.5 4.0 4.1	V
Reverse Current (V <sub>R</sub> = 5V)	I <sub>R</sub>	Hyper Red Blue Green	-	10 50 50	uA
Temperature Coefficient of λ <sub>peak</sub> I <sub>F</sub> = 20mA, -10°C ≤ T ≤ 85°C	TC <sub>λpeak</sub>	Hyper Red Blue Green	0.13 0.04 0.05	-	nm/°C
Temperature Coefficient of λ <sub>dom</sub> I <sub>F</sub> = 20mA, -10°C ≤ T ≤ 85°C	TC <sub>λdom</sub>	Hyper Red Blue Green	0.06 0.03 0.03	-	nm/°C
Temperature Coefficient of V <sub>F</sub> I <sub>F</sub> = 20mA, -10°C ≤ T ≤ 85°C	TC <sub>V</sub>	Hyper Red Blue Green	-1.9 -2.9 -2.9	-	mV/°C

**Notes:**

1. The dominant wavelength (λ<sub>d</sub>) above is the setup value of the sorting machine. (Tolerance λ<sub>d</sub> : ±1nm.)
2. Forward voltage: ±0.1V.
3. Wavelength value is traceable to CIE127-2007 standards.
4. Excess driving current and / or operating temperature higher than recommended conditions may result in severe light degradation or premature failure.

**ABSOLUTE MAXIMUM RATINGS at T<sub>A</sub>=25°C**

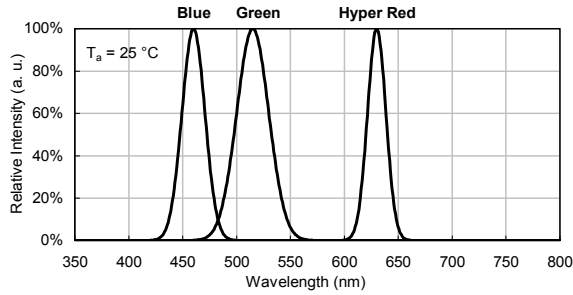
Parameter	Symbol	Value			Unit
		Hyper Red	Blue	Green	
Power Dissipation	P <sub>D</sub> [1]	75	80	82	mW
Reverse Voltage	V <sub>R</sub>	5	5	5	V
Junction Temperature	T <sub>j</sub>	110	110	110	°C
Operating Temperature	T <sub>op</sub>	-40 to +85			°C
Storage Temperature	T <sub>stg</sub>	-40 to +85			°C
DC Forward Current	I <sub>F</sub> [1]	30	20	20	mA
Peak Forward Current	I <sub>FM</sub> [2]	195	100	100	mA
Electrostatic Discharge Threshold (HBM)	-	3000	250	450	V
Thermal Resistance (Junction / Ambient)	R <sub>th JA</sub> [3]	640	610	590	°C/W
Thermal Resistance (Junction / Solder point)	R <sub>th JS</sub> [3]	530	500	480	°C/W

**Notes:**

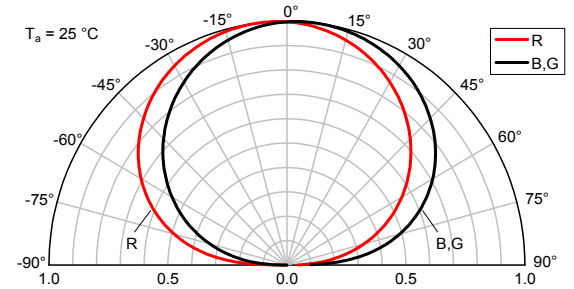
1. The maximum ratings are valid for the case of lighting a single chip  
When two chips are lit at the same time, each chip should be driven at a current lower than 50% of the absolute maximum ratings  
When three chips are lit at the same time, each chip should be driven at a current lower than 30% of the absolute maximum ratings
2. 1/10 Duty Cycle, 0.1ms Pulse Width.
3. R<sub>th JA</sub>, R<sub>th JS</sub> Results from mounting on PC board FR4 (pad size ≥ 16 mm<sup>2</sup> per pad).
4. Relative humidity levels maintained between 40% and 60% in production area are recommended to avoid the build-up of static electricity – Ref JEDEC/JESD625-A and JEDEC/J-STD-033.

## TECHNICAL DATA

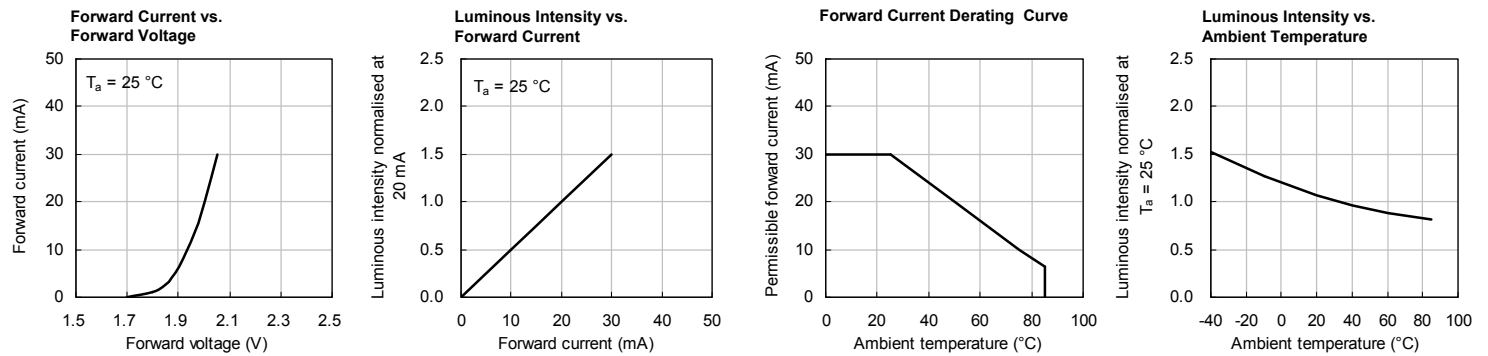
### RELATIVE INTENSITY vs. WAVELENGTH



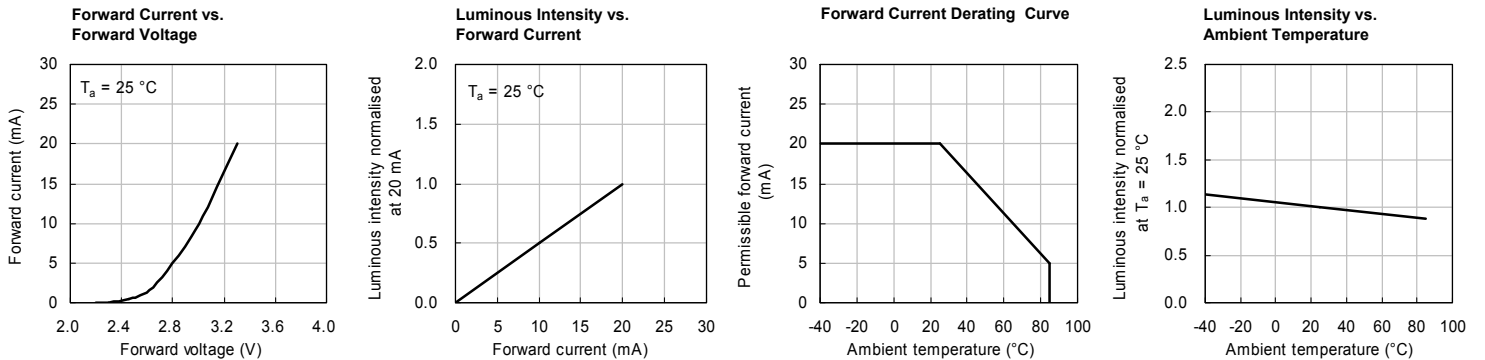
### SPATIAL DISTRIBUTION



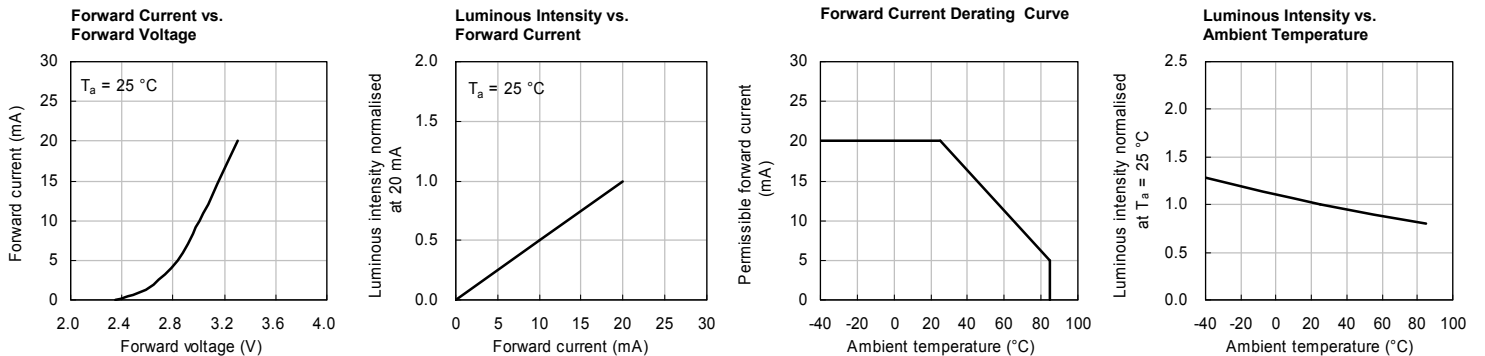
## HYPER RED



## BLUE

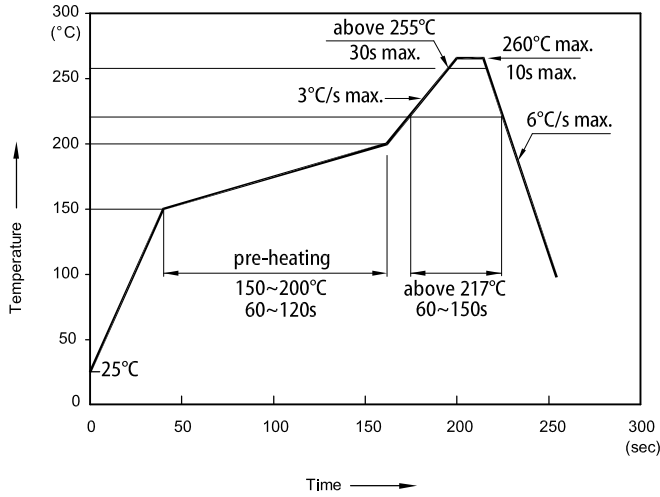


## GREEN



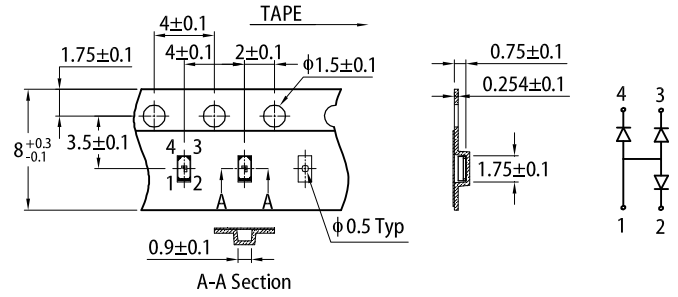
### TECHNICAL DATA

#### REFLOW SOLDERING PROFILE for LEAD-FREE SMD PROCESS

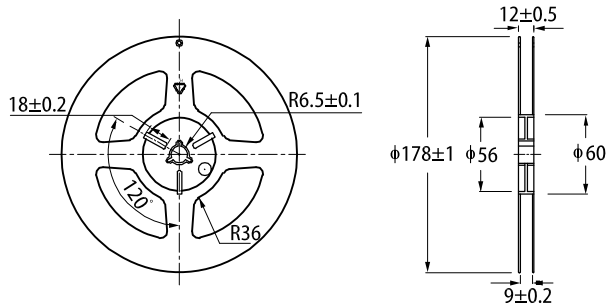


- Notes:
1. Don't cause stress to the LEDs while it is exposed to high temperature.
  2. The maximum number of reflow soldering passes is 2 times.
  3. Reflow soldering is recommended. Other soldering methods are not recommended as they might cause damage to the product.

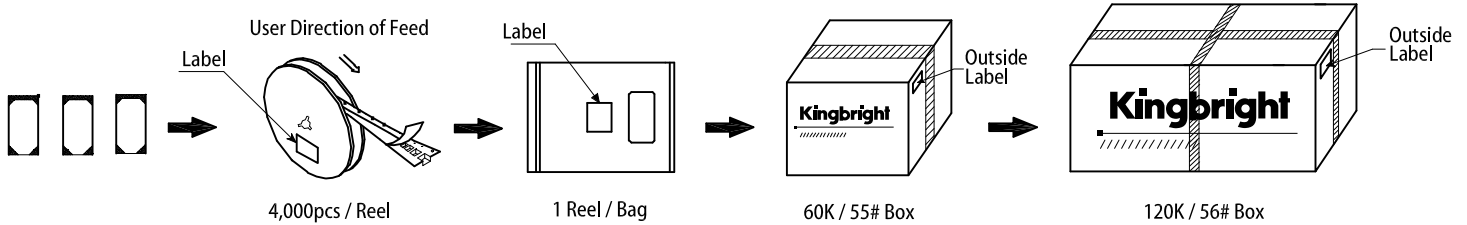
#### TAPE SPECIFICATIONS (units : mm)



#### REEL DIMENSION (units : mm)



### PACKING & LABEL SPECIFICATIONS



**Kingbright** XXXXXXXXXXXXXXXX  
 CODE: XXXX  
 D/C: XXX XX XXXX XXXXXXXXXXX-XXXX

(1P) MFG P/N: XXXXXXXXXXXXXXXX

(Q) QTY: XXXX

(9D) DATE CODE: XXXX (33P) CODE: XXXX

(4L) COO: XX

(1T) TRACEABILITY: XXXXXXXXXXX-XXXX

1 RoHS Compliant

### PRECAUTIONARY NOTES

1. The information included in this document reflects representative usage scenarios and is intended for technical reference only.
2. The part number, type, and specifications mentioned in this document are subject to future change and improvement without notice. Before production usage customer should refer to the latest datasheet for the updated specifications.
3. When using the products referenced in this document, please make sure the product is being operated within the environmental and electrical limits specified in the datasheet. If customer usage exceeds the specified limits, Kingbright will not be responsible for any subsequent issues.
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